IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application

Kokkie SCHNETZ et al.

Application No.: 10/584,068

Filed: June 22, 2006

For: IMPROVED METAL STRIP ELECTROPLATING

Examiner: Edna Wong

Group Art Unit: 1795

<u>AMENDMENT</u>

DO NOT ENTER: /EW/

12/48/2008

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

OK TOENTER ROLE
1/15/09

Sir:

In response to the Final Office action mailed September 16, 2008, please amend the above-identified application as follows: